

**Minutes of the CE-2.0 National Connectors Standards Committee
17 – 18 October 2005
Memphis, TN**

Name	Organization
Members Present	
Ralph Antonelli	DSCC-VAI
David Bouzek	Tri-Star Electronics
Al Davis	Amphenol
H. John Healy, Ph.D	IBM
Carl Fritz	Contech Research
Members Absent	
Greg Brown	Glenair
Bob Druckenmiller	FCI
Max Peel	Contech Research
Bill Peverill	WPA
Frank Ruffino	Molex Inc.
Arun Shah	Cinch
Jeff Toran	FCI Electronic
Bill Upstone (Vice Chairman)	ITT Cannon
Rick Zulkiewicz	Raytheon
Others Present	
Laird L. Macomber	Cornell Dublier
Len Metzger	Panasonic
Ed Mikowski	EIA/ECA Staff

Meeting number 37 of the National Connectors Standards Committee convened at 9:00 AM on 17 October 2005 by Vice Chairman Carl Fritz in the absence of Chairman Frank Ruffino that was attending the IEC meeting. It was noted that for the purpose of this meeting a quorum was met with the members present.

1. REVIEW AND APPROVAL OF MINUTES

The minutes of meeting No. 36 held in New Orleans, LA were unanimously moved and approved as published. The motion was made by Dave Bouzek and seconded by Ralph Antonelli.

2. CHAIRMAN’S REPORT

The issue of meeting conflicts was brought up. It was suggested that scheduling this meeting that conflicts IEC, SAE, IICIT, etc. should be avoided in the future. It was suggested that members notify EIA as soon as they know the schedule for there meeting. It was noted that SAE would be meeting the week of May 8, 2006 in Charleston, NC.

It was noted that Bill Peverill has resigned as secretary, and chairman of the CE-2.1 subcommittee on testing procedures. The members present expressed their thanks to Bill for his many years of service to the committee.

It was reported that Frank Ruffino has appointed Carl Fritz as Chairman of CE-2.0, and Chairman of CE-2.1 subcommittee on testing procedures.

Carl Fritz circulated the current EIA Contact Listing and will revise it based on this meeting. It should be noted that this is only a contact list and not an EIA member listing. (See Attachment No. 3)

3. SUBCOMMITTEE MEETINGS

CE-2.1 Test Procedures - Chairman: Carl Fritz, Vice Chairman: Max Peel

Carl Fritz convened the test procedures subcommittee. (See Attachment No. 1 for meeting report).

CE-2.2 Circular Connector Specifications - Chairman: Al Davis

Nothing to report.

CE-2.3 Rectangular Connector Specifications - Chairman: TBD

No report.

CE-2.4 Printed Board Connector Specifications - Chairman: TBD

No report.

CE-2.6 Contact Specifications - Chairman: Dave Bouzek

David Bouzek presented his report as part of the SAE report. (See Attachment No. 6)

CE-2.7 Editing Subcommittee - Chairman: Carl Fritz

Nothing special to report.

CE-2.8 International Standards Subcommittee - Chairman: Jeff Toran

Carl Fritz reported that Jeff Toran is currently attending the IEC meeting that is taking place the 14-21 October 2005 in South Africa. He has indicated that he will provide a summary of the meeting when he returns to be included with the minutes. (See Attachment No. 7 for meeting report.)

CE-2.9 Sockets Subcommittee - Chairman: TBD

Carl Fritz as facilitator convened the socket subcommittee. (See Attachment No. 2 for meeting report).

4. WORKING GROUP MEETINGS

CE-2.0.1 Contact and Connector Plating - Chairman: Bill Upstone

No report.

CE-2.0.4 Connector Outlines & Surface Mount Activities

No report.

5. SPECIAL TASK GROUP MEETINGS

STG-13-2.0 EIA-622: Terminology - Chairman: Ralph Antonelli

Ralph Antonelli provided an up date on the work he has done. He provided a report on the task group activities together with a compilation of additions to the specification. (See attachment No. 4)

STG-20-2.0 Space Requirements - Chairman: TBD

No report.

6. LIASION REPORTS

A. DSCC (Including Army, Air Force, & Navy (except NAVAIR)

Ralph Antonelli gave a project status report on activities within DSCC as well as other issues related to electrical connectors. (See Attachment No. 5)

B. NAVAIR LAKEHURST REPORT

No report.

C. SAE

Dave Bouzek presented his report. (See Attachment No. 7)

D. ASTM

No report.

E. NASA

No report.

F. IICIT

No activity.

7. NEW BUSINESS

Establish strategy on documentation structure for all new Detail Specifications, so that all existing Generic, Sectional and Blank Detail specifications are eliminated. This includes those for connectors as well as sockets.

8. FUTURE MEETINGS

The ECA Spring Summit is scheduled for 24 – 29 April 2006 in Ft. Lauderdale, FL.

The meeting adjourned at 4: 45 PM on 18 October 2005.

This meeting was conducted in accordance with EIA Legal Guidelines and EIA Manual for Organization and Procedure.

Respectfully submitted,
Carl E. Fritz, Vice Chairman